

ABSTRACT OF THE DISCLOSURE

A nonvolatile semiconductor memory package includes a memory device having a memory cell array including a plurality of nonvolatile semiconductor memory cells, a control portion configured to control the memory device, a network interface connectable to a network, a file management portion connected to the network interface configured to manage a relationship between a data file given from the network and an address of the memory cell array, and a memory interface connected to the file management portion configured to convert a signal given from the network to a signal that is capable of being used at the control portion. The package is wrapped by an insulating material.